Harvatek Surface Mount CHIP LEDs Data Sheet C3551IR--C1C-33D311

Official Product	HT Part No. C35511RC1C-33D311				
Tentative Product	*****				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/16/2019	Version 1.0	Page 1/14	

DISCLAIMER	3
LIFE SUPPORT POLICY	3
PRODUCT SPECIFICATIONS	4
ATTENTION: ELECTROSTATIC DISCHARGE (ESD) PROTECTION	4
LABEL SPECIFICATIONS	5
ELECTRO-OPTICAL CHARACTERISTICS	6
PACKAGE OUTLINE DIMENSION AND RECOMMENDED SOLDERING PATTERN FOR REFLOW	
Soldering	7
CHARACTERISTICS OF C3551IR	8
PRECAUTION FOR USE	9
PACKAGING	10
TAPE DIMENSION	10
REEL DIMENSION	11
PACKING	11
DRY PACK	11
BAKING	12
PRECAUTIONS	12
REFLOW SOLDERING	13
Reworking	13
CLEANING	13
CAUTIONS OF PICK AND PLACE	14
REVISE HISTORY	14

7					
Official Product	HT Part No. C3551IRC1C-33D311				
Tentative Product	********				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/16/2019	Version 1.0	Page 2/14	

DISCLAIMER

HARVATEK reserves the right to make changes without further notice to any products herein to improve reliability, function or design. HARVATEK does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

Life Support Policy

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.

2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

7					
Official Product	HT Part No. C3551IRC1C-33D311				
Tentative Product	*****	*****			
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/16/2019	Version 1.0	Page 3/14	

Product Specifications

ltem	Specification	Material	Quantity
Peak Wavelength	Typ:940 nm		
λ _p	@1A/ T _S = 25°C		
Radiant Intensity	Typ:1200 mW		
le	640 mW/sr		
	@1A/T _s = 25°C		
Forward Voltage	3.2-3.4 V		
V _F	@1A/ T_s= 25 $^\circ\!\mathrm{C}$;Tolerance: <u>+</u> 0.1V		
Reverse Current	< 10 µA		
I _R	@ V _R = 5 V		
Resin	Clear	Silicone	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified
			•

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Note : This is shipped test conditions

%Remarks: This product should be operated in forward bias. If a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

ATTENTION: Electrostatic Discharge (ESD) protection



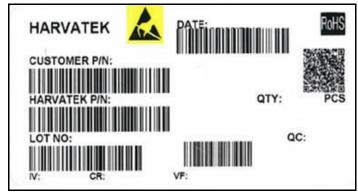
The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must

be taken during design and assembly.

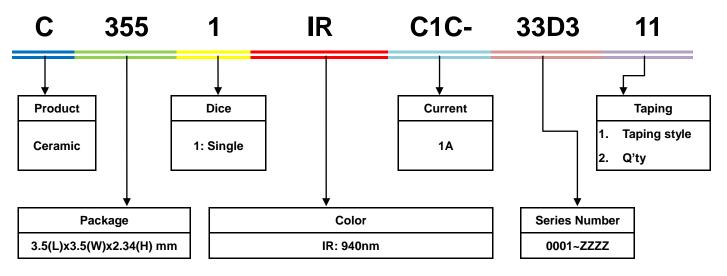
If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

7					
Official Product	HT Part No. C3551IRC1C-33D311				
Tentative Product	*******				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/16/2019	Version 1.0	Page 4/14	

Label Specifications



■Harvatek P/N:



Lot No.:

1	2	3	4	5	6	7	8	9	10
E	1	Α	1	Α	2	2	L	1	2
Cod	le 1 2	Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecuti	ve number	Special code		e
		2010-A		1:A					
		2011-B		2:B					
		2012-C	1:Jan.	3:C					
			2:Feb.						
(atomal Ta	anian Carda	2018-I/J		26:Z	01	77		000 777	
internal i r	acing Code	2019-K	A:Oct.	27:7	01-	-ZZ		000~ZZZ	
		1.00	B:Nov.	28:8					
		2022-N	C:Dec.	29:9					
		2023-P	101000000000	30:3					
		2444		31:4					

Official Product	HT Part No. C3551IRC1C-33D311				
Tentative Product	******				
Specifications are subject to changes for improvement without advance notice. Proprietary data, drawings, company confidential all rights reserved.		07/16/2019	Version 1.0	Page 5/14	

Absolute Maximum Rating at 25° C

Symbol	Parameters	Ratings	Units	Notes
١ _F	Forward Current	1000	mA	
I _{FP}	Peak Forward Current	1000	mA	1
V _R	Reverse Voltage	5	V	
T _{opr}	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	°C	2

Notes:

- 1. I_{FP} Conditions--Pulse Width $\leq\!100\mu s$ and Duty $\leq\!1\%.$
- 2. Soldering time \leq 5 seconds.

Electro-Optical Characteristics

Symbol	Parameters	Test conditions	Min	Тур	Max	Units	Notes
l _e	Radiant Intensity	I _F =1A	1100	1150	1300	mW	3
l _e	Radiant Intensity	I _F =1A	500	640	700	mW/sr	4
λ _P	Peak Wavelength	I _F =1A	-	940	-	nm	
Δλ	Spectral bandwidth at 50% of I_{max}	I _F =1A		50	-	nm	
V _F	Forward Voltage	I _F =1A	2.8	-	3.4	V	5
I _R	Reverse Current	V _R =5V	-	-	10	μA	
20 _{1/2}	Angle of Half Intensity (X)	I _F =20mA	-	90	-	deg	

Notes:

3. Radiant Intensity (mW) Bin:

Color	Bin Code	Spec. Range
IR	RR	1100-1200 mW
	RS	1200-1300 mW

4. Radiant Intensity (mW/sr) Bin:

Color	Bin Code	Spec. Range
п	RK	500-600 mW/sr
IR	RL	600-700 mW/sr

Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	*****	*****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 6/14

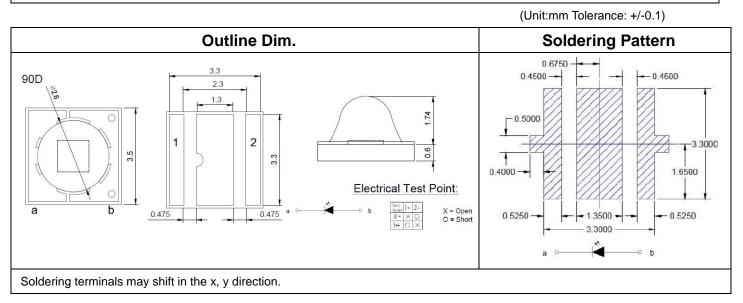
Notes:

5. Forward Voltage (V_F) Bin:

Color	Bin Code	Spec. Range
	H1	2.8-2.9 V
	H2	2.9-3.0 V
חחו	H3	3.0-3.1 V
IRP	H4	3.1-3.2 V
	J1	3.2-3.3 V
	J2	3.3-3.4 V

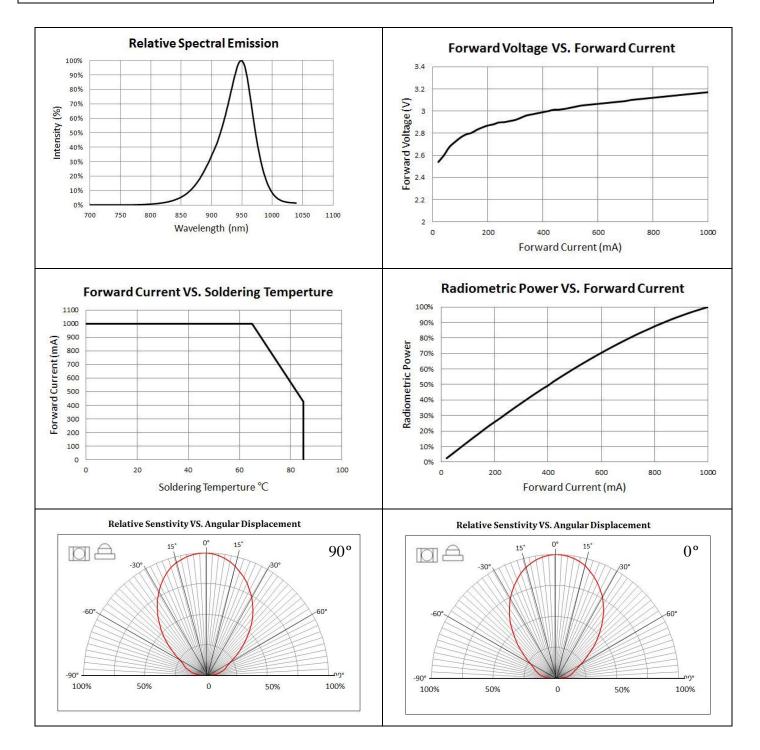
(It maintains a tolerance of ±0.1V on forward voltage measurements)

Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering



Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	******	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 7/14

Characteristics of C3551IR



Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	******	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 8/14

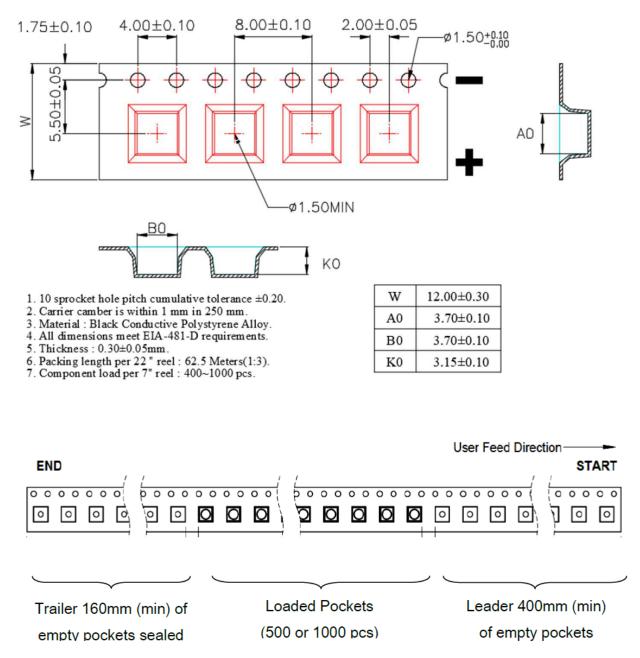
Precaution for Use

- 1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
- 2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
- 3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
- 4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
- 5. The appearance and specifications of the products may be modified for improvement without further notice.
- 6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs.If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs.Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

7				
Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	******	*****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 9/14

Packaging

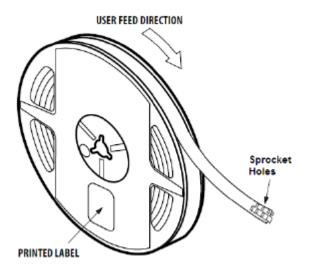
Tape Dimension



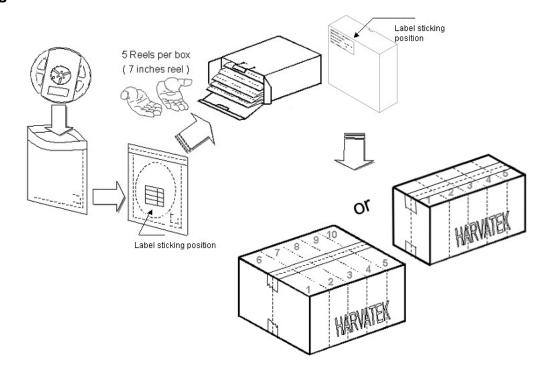
Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	*****	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 10/14



Reel Dimension



Packing



5 or 10 boxes per carton is available depending on shipment quantity.

Dry Pack

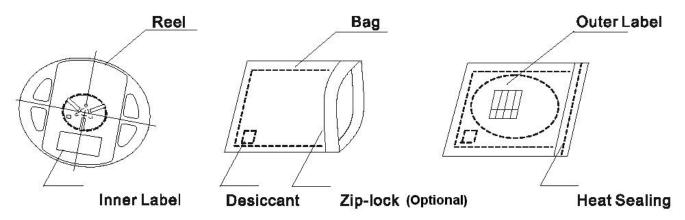
All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times

Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	*****	******		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 11/14

during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

- 1. $60\pm 3^{\circ}C \times (12 \sim 24 \text{ hrs})$ and $<5^{\circ}RH$, taped reel type.
- 2. 100±3℃×(45min~1hr), bulk type.
- 3. 130±3℃×(15min~30min), bulk type.

Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

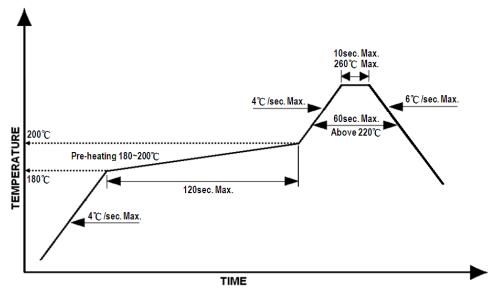
Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	*****	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 12/14

Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220 $\,^\circ\!\!\mathbb{C}$,60 sec.
- 2. Peak temp.:260 °C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- 4. Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100°C max, <3min

Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	*****	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 13/14

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Revise History

Rev.	Descriptions	Date	Page
1.0	-	07/16/2019	-

Official Product	HT Part No. C3551IRC1C-33D311			
Tentative Product	*****	****		
	t to changes for improvement without advance awings, company confidential all rights reserved.	07/16/2019	Version 1.0	Page 14/14